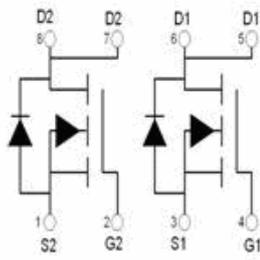
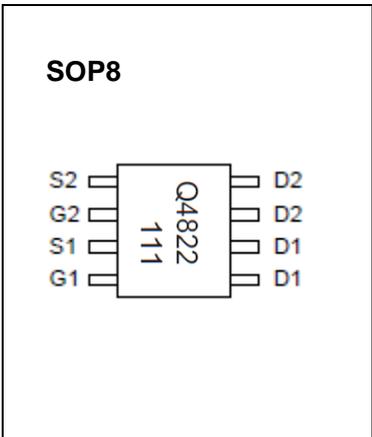


SOP8 Plastic-Encapsulate MOSFETS

CJQ4822 Dual N-Channel MOSFET

DESCRIPTION

The CJQ4822 uses advanced trench technology to provide excellent $R_{DS(ON)}$ and low gate charge. This device is suitable for use as a load switch or in PWM applications.



Maximum ratings ($T_a=25^{\circ}\text{C}$ unless otherwise noted)

Parameter	Symbol	Value	Unit
Drain-Source Voltage	V_{DS}	30	V
Gate-Source Voltage	V_{GS}	± 20	V
Continuous Drain Current ($t \leq 10\text{s}$) (note 1)	I_D	8.5	A
Pulsed Drain Current (note 2)	I_{DM}	30	A
Power Dissipation	P_D	1.4	W
Thermal Resistance from Junction to Ambient ($t \leq 10\text{s}$) (note 1)	$R_{\theta JA}$	89	$^{\circ}\text{C}/\text{W}$
Junction Temperature	T_J	150	$^{\circ}\text{C}$
Storage Temperature	T_{STG}	-55~+150	$^{\circ}\text{C}$

Electrical characteristics ($T_a=25^\circ\text{C}$ unless otherwise noted)

Parameter	Symbol	Test Condition	Min	Typ	Max	Unit
STATIC PARAMETERS						
Drain-source breakdown voltage	$V_{(BR)DSS}$	$V_{GS} = 0V, I_D = 250\mu A$	30			V
Zero gate voltage drain current	I_{DSS}	$V_{DS} = 24V, V_{GS} = 0V$			1	μA
Gate-body leakage current	I_{GSS}	$V_{GS} = \pm 20V, V_{DS} = 0V$			± 100	nA
Gate threshold voltage	$V_{GS(th)}$	$V_{DS} = V_{GS}, I_D = 250\mu A$	1		3	V
Drain-source on-resistance (note 3)	$R_{DS(on)}$	$V_{GS} = 10V, I_D = 8.5A$			16	m Ω
		$V_{GS} = 4.5V, I_D = 6A$			26	m Ω
Forward transconductance (note 3)	g_{fs}	$V_{DS} = 5V, I_D = 8.5A$		20		S
Diode forward voltage (note 3)	V_{SD}	$I_S = 1A, V_{GS} = 0V$			1	V
DYNAMIC PARAMETERS (note 4)						
Input capacitance	C_{iss}	$V_{DS} = 15V, V_{GS} = 0V, f = 1MHz$			1250	pF
Output capacitance	C_{oss}			180		pF
Reverse transfer capacitance	C_{rss}			110		pF
SWITCHING PARAMETERS (note 4)						
Turn-on delay time	$t_{d(on)}$	$V_{GS} = 10V, V_{DS} = 15V,$ $R_L = 1.8\Omega, R_{GEN} = 3\Omega$			7.5	ns
Turn-on rise time	t_r				6.5	ns
Turn-off delay time	$t_{d(off)}$				25	ns
Turn-off fall time	t_f				5	ns
Total gate charge (10V)	Q_g	$V_{DS} = 15V, V_{GS} = 10V, I_D = 8.5A$			23	nC
Total gate charge (4.5V)					11.2	nC
Gate-source charge	Q_{gs}			2.6		nC
Gate-drain charge	Q_{gd}			4.2		nC

Notes :

1. The value of $R_{\theta JA}$ is measure with the device mounted on 1in² FR-4 board with 2oz. Copper, in a still air environment with $T_a=25^\circ\text{C}$. The value in any given application depends on the user's specific board design. The current rating is based on the $t \leq 10s$ thermal resistance rating.
2. Repetitive rating : Pulse width limited by junction temperature.
3. Pulse Test : Pulse Width $\leq 300\mu s$, Duty Cycle $\leq 2\%$.
4. Guaranteed by design, not subject to production testing.